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Vishay Semiconductors

RoHS

COMPLIANT

HALOGEN FREE

GREEN

High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY294310 series are infrared, 940 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

APPLICATIONS

- · Miniature light barrier
- Photointerrupters
- · Optical switch
- Emitter source for proximity sensors
- IR illumination

FEATURES

Package type: surface mountPackage form: GW, RGW



Peak wavelength: λ_p = 940 nm

· High reliability

• High radiant power

Very high radiant intensity

• Angle of half intensity: $\phi = \pm 25^{\circ}$

Suitable for high pulse current operation

Terminal configurations: gullwing or reverse gullwing

Package matches with detector VEMD2503X01 series

• Floor life: 4 weeks, MSL 2a, acc. J-STD-020

 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMY294310RG	25	± 25	940	10
VSMY294310G	25	± 25	940	10

Note

· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY294310RG	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMY294310G	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	

Note

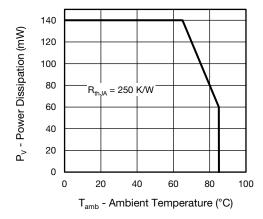
• MOQ: minimum order quantity



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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V _R	5	V
Forward current		I _F	70	mA
Surge forward current	t _p = 100 μs	I _{FSM}	1	Α
Power dissipation		P _V	140	mW
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	-40 to +85	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Soldering temperature	Acc. figure 7, J-STD-020	T _{sd}	260	°C
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R _{thJA}	250	K/W



70 I_F - Forward Current (mA) 60 50 40 30 $R_{thJA} = 250 \text{ K/W}$ 20 10 0 100 0 20 40 60 80 T_{amb} - Ambient Temperature (°C)

80

Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	V _F	-	1.5	2.0	V
	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	V _F	-	2.5	-	V
Temperature coefficient of V _F	I _F = 20 mA	TK _{VF}	-	-1.7	-	mV/K
Reverse current		I _R	not designed for reverse operation		μΑ	
Junction capacitance	$V_R = 0 \text{ V, f} = 1 \text{ MHz, E} = 0 \text{ mW/cm}^2$	CJ	-	5	-	pF
Radiant intensity	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	l _e	12	25	45	mW/sr
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	l _e	-	260	-	mW/sr
Radiant power	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	фe	-	40	-	mW
Temperature coefficient of radiant power	I _F = 70 mA	TΚφ _e	-	-0.2	-	%/K
Angle of half intensity		φ	-	± 25	-	deg
Peak wavelength	I _F = 20 mA	λ_{p}	920	940	960	nm
Spectral bandwidth	I _F = 20 mA	Δλ	-	35	-	nm
Temperature coefficient of λ_p	I _F = 20 mA	TKλ _p	-	0.25	-	nm/K
Rise time	I _F = 70 mA, 20 % to 80 %	t _r	-	10	-	ns
Fall time	I _F = 70 mA, 20 % to 80 %	t _f	-	10	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

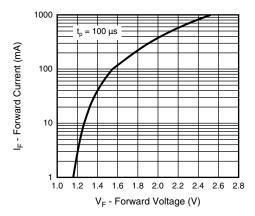


Fig. 3 - Forward Current vs. Forward Voltage

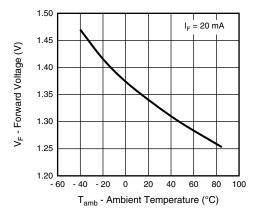


Fig. 4 - Forward Voltage vs. Ambient Temperature

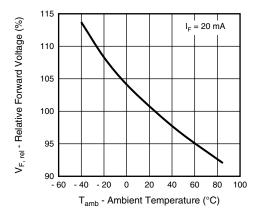


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

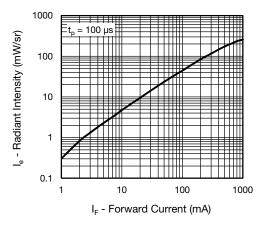


Fig. 6 - Radiant Intensity vs. Forward Current

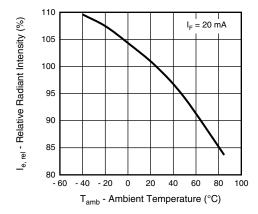


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

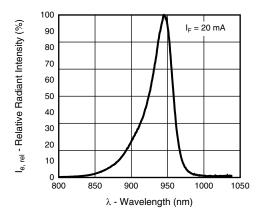


Fig. 8 - Relative Radiant Intensity vs. Wavelength

VSMY294310RG, VSMY294310G

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DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 %.

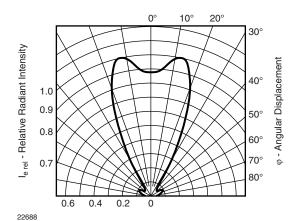


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

SOLDER PROFILE

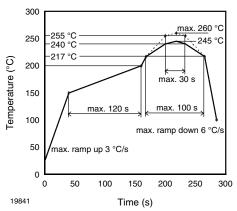
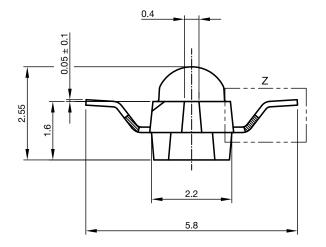
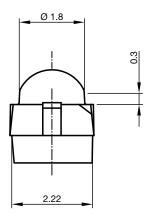
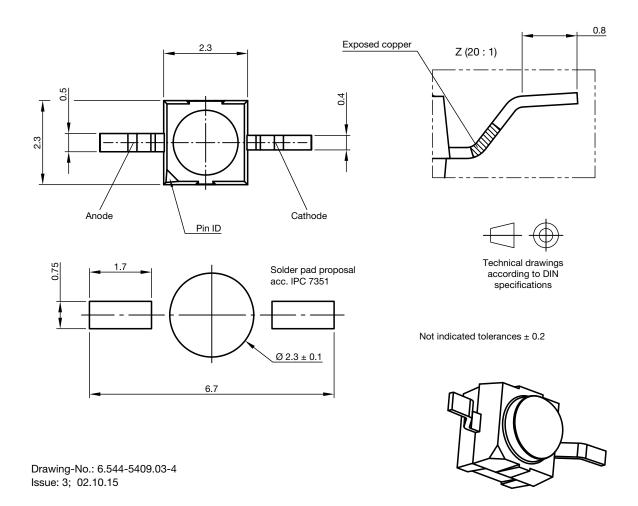


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

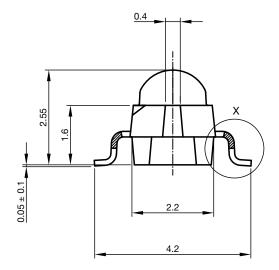
PACKAGE DIMENSIONS in millimeters: VSMY294310RG

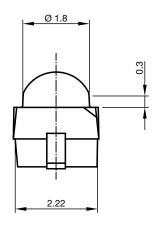


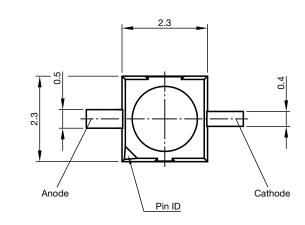


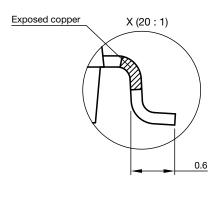


PACKAGE DIMENSIONS in millimeters: VSMY294310G



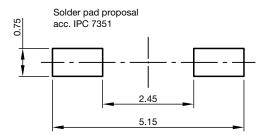




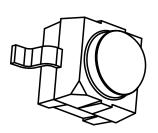




Technical drawings according to DIN specifications



Not indicated tolerances ± 0.2

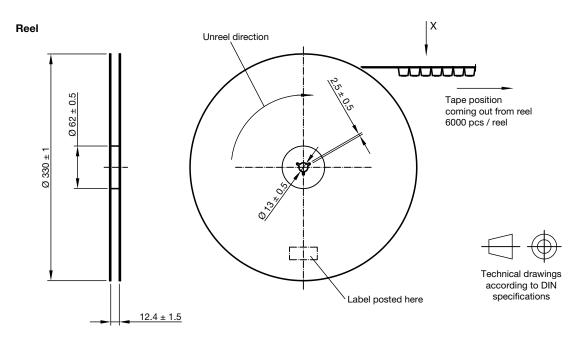


Drawing-No.: 6.544-5408.03-4

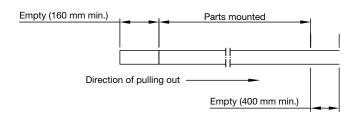
Issue: 3; 02.10.15



TAPING AND REEL DIMENSIONS in millimeters: VSMY294310RG

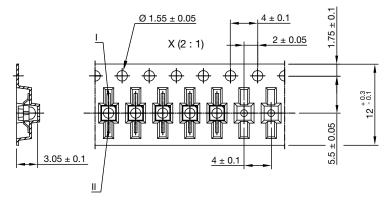


Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II
VSMB2943RGX01		
VSMF2893RGX01	Cathode	Anode
VEMD2x03X01		
VEMT2x03X01	Collector	Emitter
VSMY2853RG		
VSMY2943RG	Anode	Cathode
VSMY294310RG		

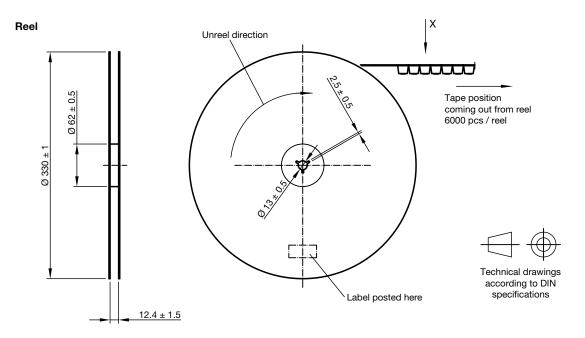


Drawing-No.: 9.800-5100.02-4

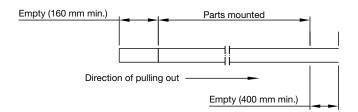
Issue: 3; 02.10.15



TAPING AND REEL DIMENSIONS in millimeters: VSMY294310G

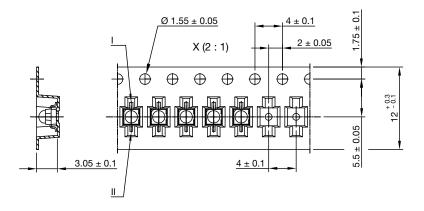


Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II
VSMB2943GX01		
VSMF2893GX01	Cathode	Anode
VEMD2x23X01		
VEMT2x23X01	Collector	Emitter
VSMY2853G		
VSMY2943G	Anode	Cathode
VSMY294310G		



Drawing-No.: 9.800-5091.21-4

Issue: 3; 02.10.15



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